

ABSTRACT

SLOTTED SUBSTRATES AND METHODS AND SYSTEMS FOR FORMING
SAME

Methods and systems for forming compound slots (304) in a substrate (306) are described. In one exemplary implementation, a method forms a plurality of slots (504) in a substrate (306). The method also etches a trench (502) in the substrate (306) contiguous with the plurality of slots (504) to form a compound slot (304).

(Fig. 6)

